

**AMENDMENTS****In the Specification:**

Please amend page 12, lines 1-12 as follows:

When the, next, as is illustrated by an Arrow L (and as was already explained above), the corresponding semiconductor device 3a is (e.g. by means of the above mentioned loading machine 10) introduced in the carrier 11a (and the carrier 11a is then, in a manner known per se, closed), corresponding semiconductor device contacts 101, 100a, 100b (that are, for instance, provided at the bottom of semiconductor device 3a, and e.g. are shown in Fig. 4) get into contact with corresponding contacts 102a, 102b at the carrier 11a (that are, for instance, provided at the top of the carrier 11a, and e.g. as also show in Fig. 4) (the contacts being connected with the above-mentioned carrier pads contacting the socket pads).

Please amend page 7 of applicant's specification by adding the following after line 23:

Figure 4 shows a semiconductor device and a carrier in accordance with an exemplary embodiment of the invention.